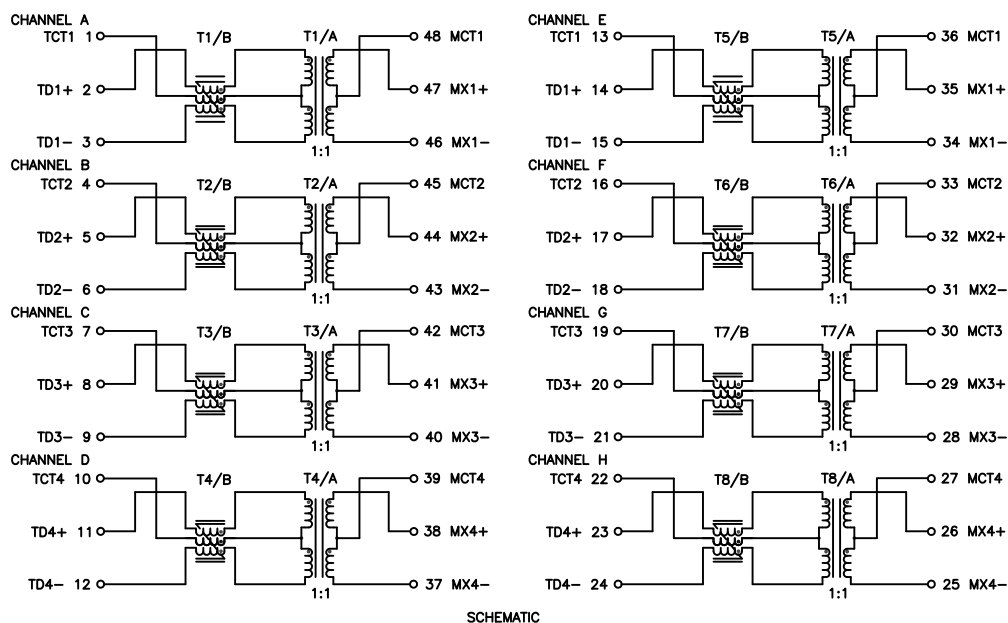


NOTES: UNLESS OTHERWISE SPECIFIED

1.

NOTICE:	THIS IS A RoHS COMPLIANT COMPONENT/PRODUCT. ALL ENGINEERING CHANGES MUST HAVE PRIOR APPROVAL BY THE DESIGN CENTER.
RoHS	

2. HEADER: THERMOSET MATERIAL WITH FLAMMABILITY RATING UL 94V-0 OR BETTER.
3. PCB CONTACTS SOLDER AREA: SN100C TIN PLATING.
4. SOLDERABILITY: CONFORMS TO ANSI/J-STD-002, IPC/EIA J-STD-003A.
5. OPERATING TEMPERATURE: -40°C TO +85°C
6. STORAGE TEMPERATURE: -50°C TO +125°C
7. JEDEC MOISTURE: LEVEL 1.
8. REVISION: MX1,MX2, ARE PRELIMINARY.



ELECTRICAL CHARACTERISTICS AT +25°C UNLESS OTHERWISE SPECIFIED
(FOR REFERENCE ONLY. USED FOR CUSTOMER INFORMATION.)

PARAMETER	SPECIFICATIONS	
OPERATING TEMP	-40°C TO +85°C	
URNS RATIO	1 : 1 ±3%	
POLARITY	PER SCHEMATIC	
INSERTION LOSS	100 KHz	1-125 MHz
	-1.2 dB MAX	-0.2-0.002*f ^{1.4} dB MAX
RETURN LOSS (Z OUT = 100 OHM ±15%)	1-40 MHz	40-100 MHz
	-16 dB MIN	-10+20*LOG ₁₀ (f/80 MHz) dB MIN
INDUCTANCE (OCL) (MEDIA SIDE, -40°C TO +85°C)	350 uH MIN	(MEASURED AT 100 KHz, 100 mVRMS) (WITH 8 mA DC BIAS)
	120 uH MIN	(MEASURED AT 100 KHz, 100 mVRMS) (WITH 19 mA DC BIAS)
CROSSTALK, ADJACENT CHANNELS	1 MHz	10-100 MHz
	-50 dB MIN	-55+22*LOG ₁₀ (f/10) dB MIN
COMMON MODE REJECTION RATIO	2 MHz	30-200 MHz
	-50 dB MIN	-15+20*LOG ₁₀ (f/200) dB MIN
DC RESISTANCE, 1/2 WINDING	.30 OHMS TYP.	
DC RESISTANCE BALANCE	±.05 OHMS MAX (CENTER TAP SYMMETRY)	
INPUT - OUTPUT ISOLATION	1500 VRMS MIN @ 60 SECONDS	

NOTE: f IS FREQUENCY IN MHZ.

